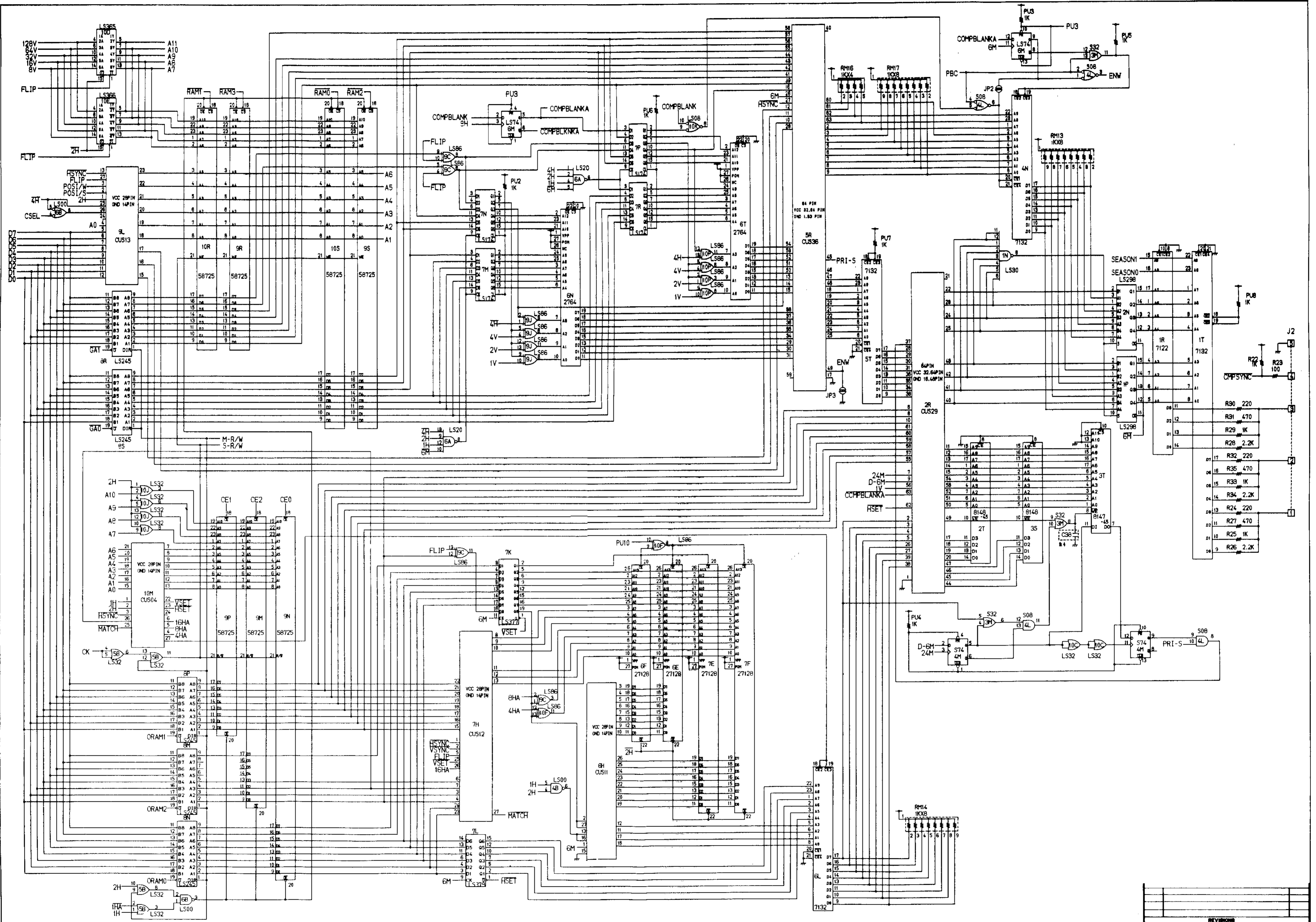


PROJECT ENG: J. SZERSZEN		USED ON PACLAND		REVISIONS	
DO NOT SCALE DWG		NO. REFS 1 OF 3		Reddy / MIDWAY MFG. CO. FRANKLIN PK. ILL.	
DIM TOLERANCES UNLESS SPECIFIED		SCHEMATIC DWG.		PART NO.	
CONCENTRICITY F1.00		PACLAND LOGIC		MOSI - 00B64 - A010	
FRACTIONAL F1/4		A084-91769-AB64			
DECIMAL F.00		DATE 9/31/84			
HOLE DIA F.00					



PROJECT ENG: J. SZERSZEN		USED ON: PACLAND		FRANKLIN PK. ILL.	
DO NOT SCALE DWG.		NO. REV'D: 2 OF 3	PART NO. MOSI - 00B64 - 0A10		
DIM TOLERANCES UNLESS SPECIFIED		SCHEMATIC DWG. PACLAND LOGIC		A084 - 91769 - AB64	
DATE: 9/31/84		DRAWN: [signature]		CHECKED: [signature]	

The upside down error codes are as follows :-

leftmost digit = MCU (sub-cpu) error code

0 = sub-cpu woke up OK

1 = sub-cpu internal ROM failure or sub-cpu failed to wake up

middle digit = eprom error (only positions 8B, 8D (main cpu) and 3E (sub-cpu) are checked)

0 = all 3 code eproms good

1 = eprom @ 8B failed checksum

2 = eprom @ 8D failed checksum

7 = eprom @ 3E (sub-cpu) failed checksum

rightmost digit = ram error

0 = all rams good

1 = work ram @ 9M bad (addresses \$3000-\$37ff)

2 = work ram @ 9N bad (addresses \$2000-\$27ff)

3 = work ram @ 9P bad (addresses \$2800-\$2fff)

4 = tile ram @ 9R bad (odd bytes - addresses \$0000-\$0fff)

5 = tile ram @ 9S bad (even bytes - addresses \$0000-\$0fff)

6 = tile ram @ 10R bad (odd bytes - addresses \$1000-\$1fff)

7 = tile ram @ 10S bad (even bytes - addresses \$1000-\$1fff)

9 = shared ram @ 3J/3K bad (one or both are bad)

The ghost character has no significance, it's merely there to look pretty.